

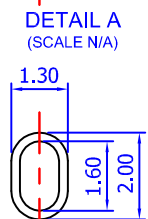
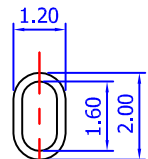
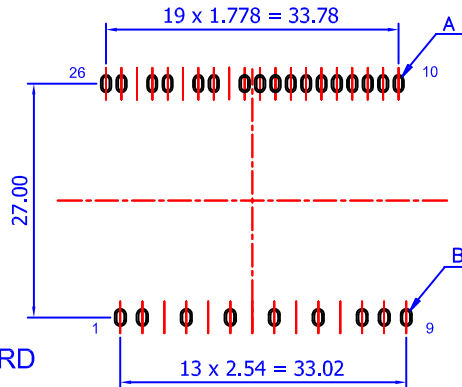
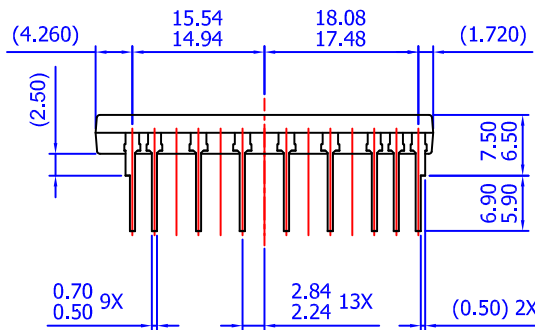
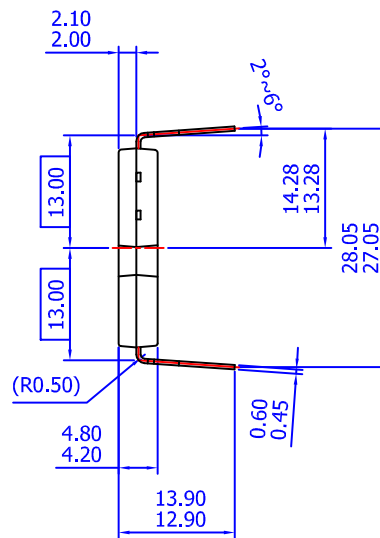
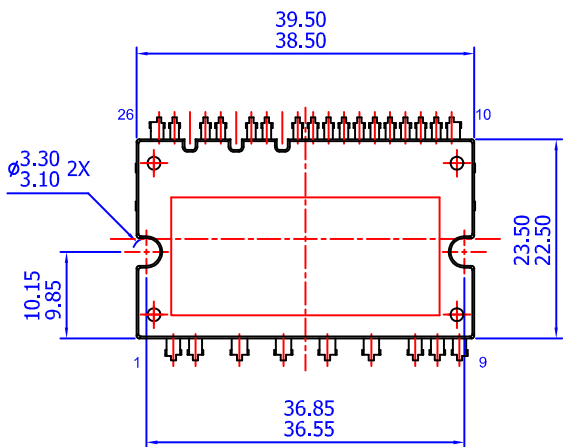
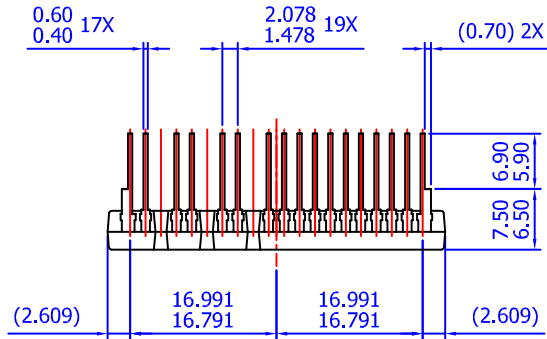
MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

ON Semiconductor®



SPMAA-C26 / 26LD, PDD STD CERAMIC TYPE, LONG LEAD DUAL FORM TYPE CASE MODFC ISSUE O

DATE 31 JAN 2017



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 B) ALL DIMENSIONS ARE IN MILLIMETERS
 C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
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